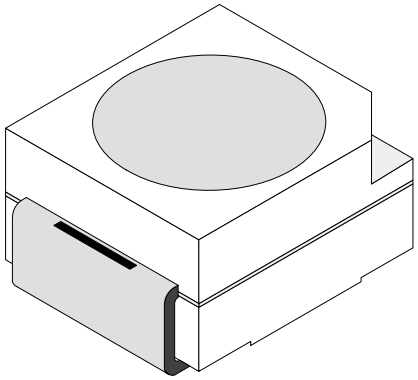
TLMB3100

Blue SMD LED

Color	Type	Technology	Angle of Half Intensity ±φ
Blue	TLMB3100	SiC	60°

Description

These devices have been designed to meet the increasing demand for surface mounting technology.
The package of the TLMB3100 is the PL–CC–2 (equivalent to a size B tantalum capacitor).
It consists of a lead frame which is surrounded with a white thermoplast. The reflector inside this package is filled up with clear epoxy.



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Features

- SMD LED with exceptional brightness
- Blue Color
- Luminous intensity categorized
- Compatible with automatic placement equipment
- EIA and ICE standard package
- Compatible with infrared, vapor phase and wave solder processes according to CECC
- Available in 8 mm tape
- Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- Luminous intensity ratio in one packaging unit $I_{Vmax}/I_{Vmin} \leqq 2.0$

Applications

Blue indicators
Blue displays
Blue light source for spectrophotometers, colorimeters, blood analysers, tissue analysers

TLMB3100

Absolute Maximum Ratings

T_{amb} = 25°C, unless otherwise specified

TLMB3100

Parameter	Test Conditions	Type	Symbol	Value	Unit
Reverse voltage			V_R	6	V
DC forward current			I_F	30	mA
Power dissipation	$T_{amb} \leq 60^\circ C$		P_V	100	mW
Junction temperature			T_j	100	°C
Operating temperature range			T_{amb}	–20 to +80	°C
Storage temperature range			T_{stg}	–55 to +100	°C
Soldering temperature	t ≤ 5 s		T_{sd}	260	°C
Thermal resistance junction/ambient	mounted on PC board (pad size > 16 mm^2)		R_{thJA}	400	K/W

Optical and Electrical Characteristics

T_{amb} = 25°C, unless otherwise specified

Blue (TLMB3100)

Parameter	Test Conditions	Type	Symbol	Min	Typ	Max	Unit
Luminous intensity	I_F = 20 mA		I_V		0.5		mcd
Luminous flux	I_F = 20 mA		ϕ_V		2		mlm
Dominant wavelength	I_F = 20 mA		λ_d		470		nm
Angle of half intensity	I_F = 10 mA		φ		±60		deg
Forward voltage	I_F = 20 mA		V_F		3.1	3.5	V
Reverse voltage	I_R = 10 µA		V_R	6	60		V

Typical Characteristics (T_{amb} = 25°C, unless otherwise specified)

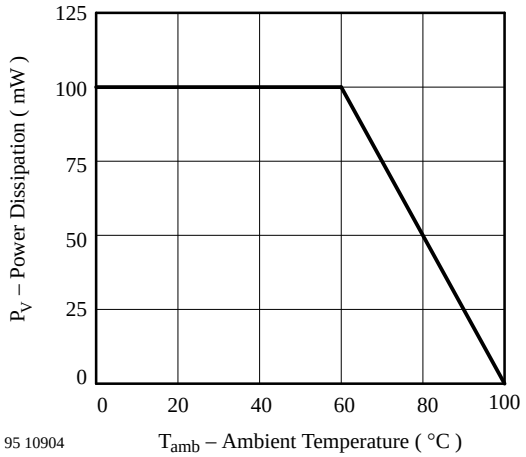


Figure 1. Power Dissipation vs. Ambient Temperature

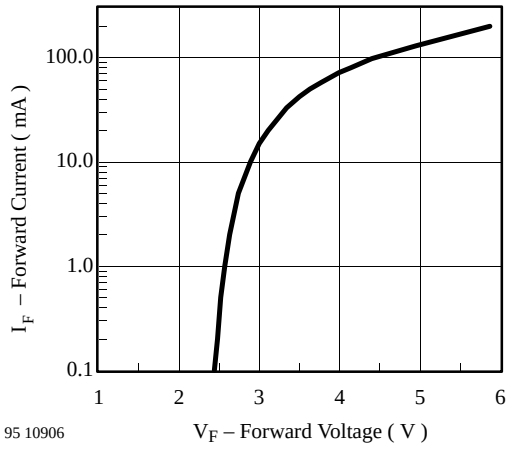


Figure 4. Forward Current vs. Forward Voltage

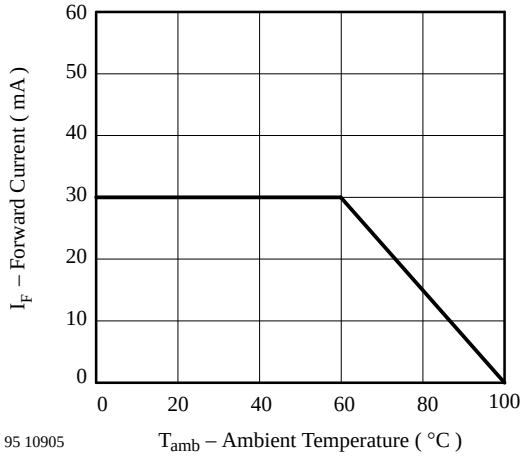


Figure 2. Forward Current vs. Ambient Temperature

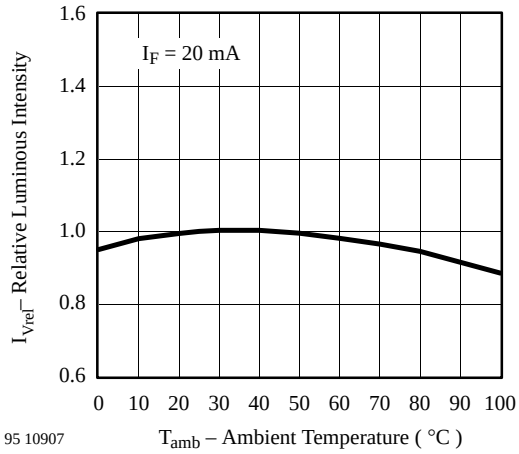


Figure 5. Rel. Luminous Intensity vs. Ambient Temperature

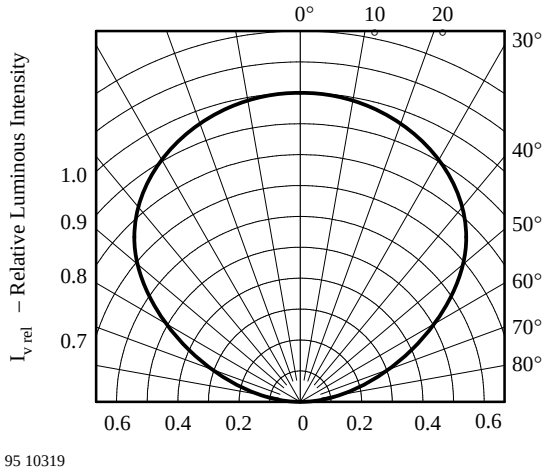


Figure 3. Rel. Luminous Intensity vs. Angular Displacement

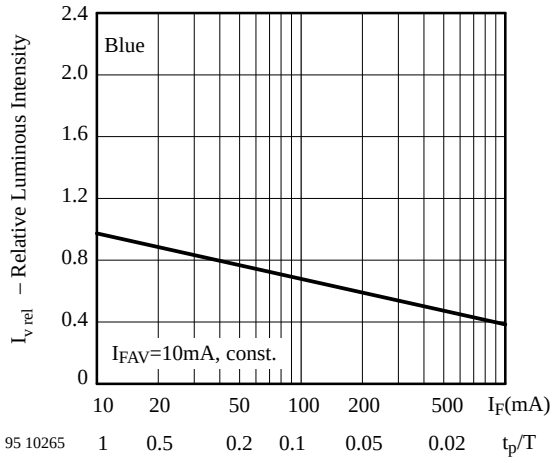


Figure 6. Rel. Lumin. Intensity vs. Forw. Current/Duty Cycle

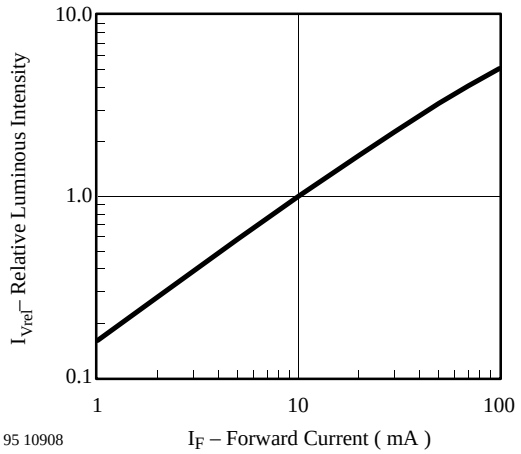


Figure 7. Relative Luminous Intensity vs. Forward Current

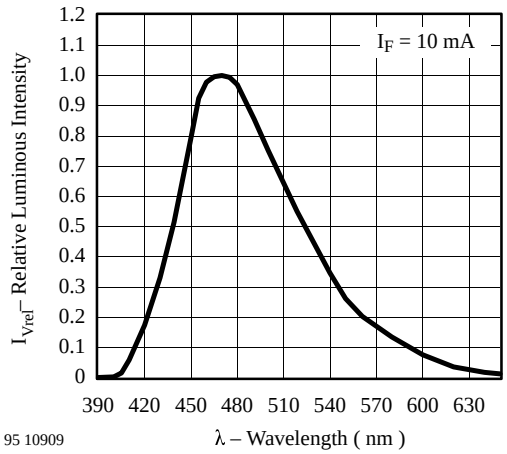
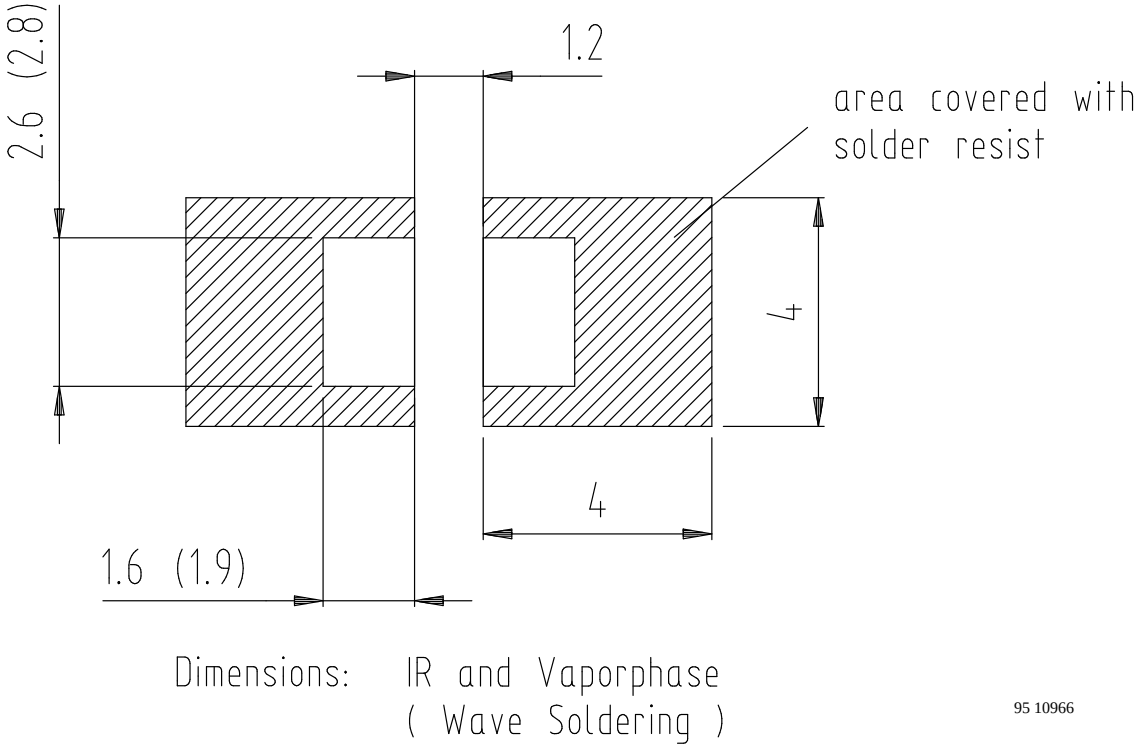
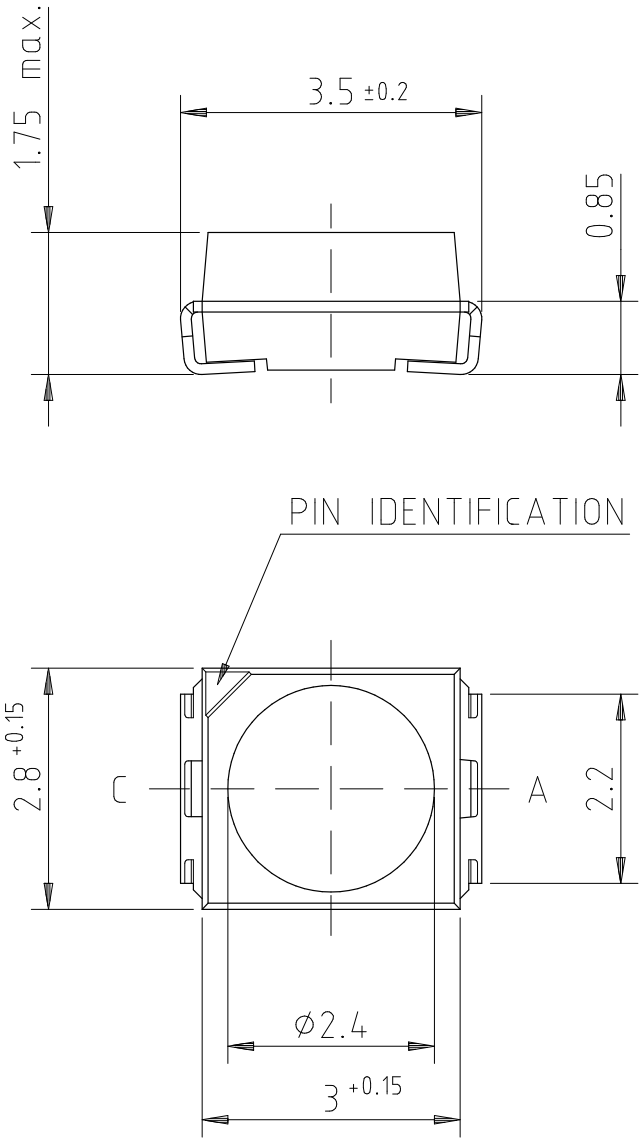


Figure 8. Relative Luminous Intensity vs. Wavelength

PCB Layout in mm



Dimensions in mm



technical drawings
according to DIN
specifications

Ozone Depleting Substances Policy Statement

It is the policy of **TEMIC TELEFUNKEN microelectronic GmbH** to

1. Meet all present and future national and international statutory requirements.

2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively

2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA

3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

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